# MICROCHIP

# MX554EBG16M0000

#### **Ultra-Low Jitter 16MHz LVDS XO**

#### ClockWorks® FUSION

## **General Description**

The MX554EBG16M0000 is an ultra-low phase jitter XO with LVDS output optimized for high line rate applications.

#### **Features**

- 16MHz LVDS
- Typical phase noise:
  - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

## Absolute Maximum Ratings<sup>1</sup>

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T <sub>S</sub> ) ESD Machine Model	65°C to +125°C
ESD Machine Model	200V
ESD Rating (HBM)	2kV

## Operating Ratings<sup>2</sup>

Supply Voltage (VIN)	+ $2.375V$ to $+3.63V$
Ambient Temperature (TA)	40°C to $+85$ °C
Junction Thermal Resistance	
LGA (T <sub>IC</sub> ) Still Air	58°C/W
` JC ′	

#### **Electrical Characteristics**

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 100 Ohms between Q and /Q.<sup>3</sup>

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current			90	100	mA
F0	Center Frequency			16		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		400	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage VOH max = VCM max + 1/2 VOD max	LVDS output levels	1.248	1.375	1.602	V
VOL	Output Low Voltage VOL min = VCM min - 1/2 VOD max	LVDS output levels	0.898	1.025	1.252	V
VOD	Output Differential Voltage		247	350	454	mV
VCM	Common Mode Output Voltage		1.125	1.2	1.375	V

#### Notes:

- 1. Exceeding the absolute maximum ratings may damage the device.
- $2. \ The \ device is not guaranteed to function outside its operating ratings.$
- $3.\ Guaranteed\ after\ thermal\ equilibrium.$
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

ClockWorks is a registered trademark of Microchip Technology Inc.

Microchip Technology Inc.

http://www.microchip.com

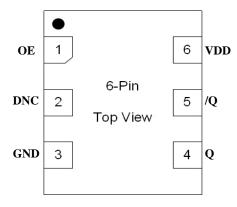
July 07, 2020 MX554EB1-9124 Revision 1.0 tcghelp@microchip.com

# **Ordering Information**

<b>Ordering Part Number</b>	Marking Line 1	Marking Line 3	Shipping	Package
MX554EBG16M0000	MX554E	BG0160	Tube	6-Pin 5mm x 3.2mm LGA
MX554EBG16M0000-TR	MX554E	BG0160	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

# **Pin Configuration**



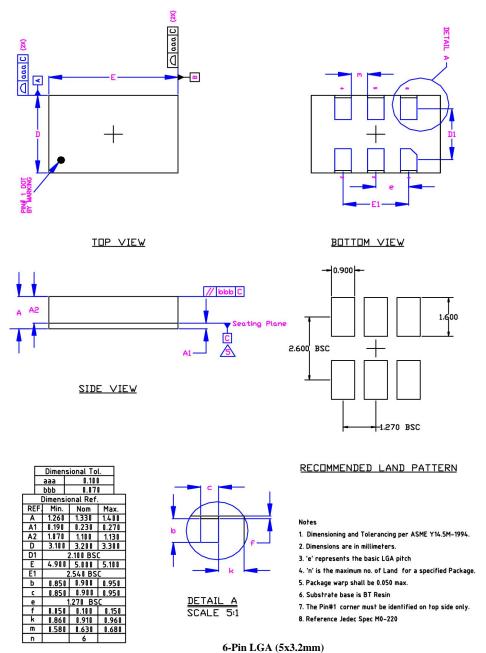
# **Pin Description**

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 1 = Disabled, 0 = Enabled, 50k Ohms Pull-Down (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVDS	Clock Output Frequency = 16MHz
6	VDD	PWR		Power Supply

# **Environmental Specifications**

Thermal Shock	MIL-STD-883, Method 1011, Condition A		
Moisture Resistance	MIL-STD-883, Method 1004		
Mechanical Shock	MIL-STD-883, Method 2002, Condition C		
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A		
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)		
Hazardous Substance	Pb-Free / RoHS / Green Compliant		
Solderability	JESD22-B102-D Method 2 (Preconditioning E)		
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D		
Gross Leak	MIL-STD-883, Method 1014, Condition C		
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s		
MSL Level	Crystal - MSL-1, Package MSL-3		
Solvent Resistance	MIL-STD-202, Method 215		

### Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



#### Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

#### Microchip Technology Inc.

## http://www.microchip.com

Microchip makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Microchip does not assume responsibility for its use. Microchip reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Microchip's terms and conditions of sale for such products, Microchip assumes no liability whatsoever, and Microchip disclaims any express or implied warranty relating to the sale and/or use of Microchip products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

© 2020 Microchip Technology Inc.